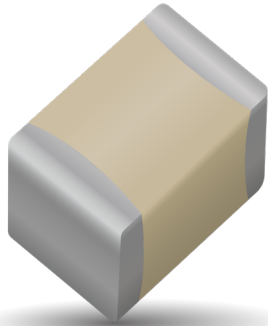


RF/Microwave Capacitors

RF/Microwave Multilayer Capacitors (MLC)

100B Series Porcelain Superchip® Multilayer Capacitors



FEATURES

- Case B Size (.110" x .110")
- Capacitance Range 0.1pF to 1000pF
- Extended WVDC up to 1500 VDC
- Low ESR/ESL
- High Q
- Low Noise
- Ultra-Stable Performance
- High Self-Resonance
- Established Reliability (QPL)

GENERAL DESCRIPTION

KYOCERA AVX, the industry leader, offers new improved ESR/ESL performance for the 100 B Series RF/Microwave Capacitors. This Series is now available with extended operating temperatures up to 175°C. High Density porcelain construction provides a rugged, hermetic package.

FUNCTIONAL APPLICATIONS

- Bypass
- Impedance Matching
- Coupling
- DC Blocking
- Tuning

CIRCUIT APPLICATIONS

- UHF/Microwave RF Power Amplifiers
- Low Noise Amplifiers
- Oscillators
- Filter Networks
- Timing Circuits

ENVIRONMENTAL CHARACTERISTICS

Thermal Shock	Mil-STD-202, Method 107, Condition A
Moisture Resistance	Mil-STD-202, Method 106
Low Voltage Humidity	Mil-STD-202, Method 103, condition A, with 1.5 VDC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours
Life Test	MIL-STD-202, Method 108, for 2000 hours, at 125°C. Voltage applied. 200% of WVDC for capacitors rated at 500 volts DC or less. 120% of WVDC for capacitors rated at 1250 volts DC or less. 100% of WVDC for capacitors rated above 1250 volts DC
Termination Styles	Available in various surface mount and leaded styles. See Mechanical Configurations
Terminal Strength	Terminations for chips and pellets withstand a pull of 5 lbs. min., 15 lbs. typical, for 5 seconds in direction perpendicular to the termination surface of the capacitor.

PACKAGING OPTIONS



Tape & Reel



Vertical Orientation Tape & Reel



Cap Pac® (100 pcs)



ELECTRICAL SPECIFICATIONS

Temperature Coefficient (TCC)	+90 ±20 PPM/°C (-55°C to +125°C) +90 ±30 PPM/°C (+125°C to +175°C)
Capacitance Range	0.1pF to 1000pF
Operating Temperature	Standard WVDC: 0.1 to 330pF: from -55°C to +175°C 360 to 1000pF: from -55°C to +125°C Extended WVDC: 0.1 to 1000pF: from -55°C to +125°C (No derating of working voltage)
Quality Factor	greater than 10,000 at 1 MHz
Insulation Resistance (IR)	0.1 pF to 470 pF: 10 ⁶ Megohms min. @ +25°C at rated WVDC. 10 ⁵ Megohms min. @ +125°C at rated WVDC. 510 pF to 1000 pF: 10 ⁵ Megohms min. @ +25°C at rated WVDC. 10 ⁴ Megohms min. @ +125°C at rated WVDC.
Working Voltage (WVDC)	See Capacitance Values table
Dielectric Withstanding Voltage (DWV)	250% of WVDC for capacitors rated at 500 volts DC or less for 5 seconds. 150% of WVDC for capacitors rated at 1250 volts DC or less for 5 seconds. 120% of WVDC for capacitors rated above 1250 Volts DC for 5 seconds
Aging Effects	None
Piezoelectric Effects	None
Capacitance Drift	± (0.02% or 0.02 pF), whichever is greater
Retrace	Less than ±(0.02% or 0.02 pF), whichever is greater.

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CAPACITANCE VALUES

Cap. Code	Cap. (pF)	Tol.	Rated WVDC		Cap. Code	Cap. (pF)	Tol.	Rated WVDC		Cap. Code	Cap. (pF)	Tol.	Rated WVDC		CAP. CODE	CAP. (pF)	TOL.	RATED WVDC			
			STD.	EXT.				STD.	EXT.				STD.	EXT.				STD.	EXT.		
0R1	0.1	B	500	EXTENDED VOLTAGE	2R4	2.4	B, C, D	500	1500	200	20	F, G, J, K, M	500	1500	151	150	F, G, J, K, M	300	EXT.		
0R2	0.2				2R7	2.7				220	22				161	160			1000		
0R3	0.3	3R0			3.0	240				24	181				180	VOLT.					
0R4	0.4	3R3			3.3	270				27	201				200						
0R5	0.5	B, C, D			EXTENDED VOLTAGE	3R6				3.6	300				30	221		220	200	EXT.	
0R6	0.6					3R9				3.9	330				33	241		240			VOLT.
0R7	0.7					4R3				4.3	360				36	271		270			
0R8	0.8					4R7				4.7	390				39	301		300			600
0R9	0.9					5R1				5.1	430				43	331		330		VOLT.	
1R0	1.0					5R6				5.6	470				47	361		360			EXT.
1R1	1.1					6R2				6.2	510				51	391		390		100	
1R2	1.2					6R8	6.8			560	56				431	430		300			
1R3	1.3					7R5	7.5			620	62				471	470				VOLT.	
1R4	1.4					8R2	8.2			680	68				511	510		EXT.			
1R5	1.5	9R1		9.1	750	75	561			560	100										
1R6	1.6	B, C, D		EXTENDED VOLTAGE	100	10	621			620			50	300							
1R7	1.7				110	11	910			91	681				680	VOLT.					
1R8	1.8				120	12	101			100	751				750						
1R9	1.9				130	13	111			110	821				820						
2R0	2.0				150	15	121			120	911			910	50	VOLT					
2R1	2.1				160	16	131			130	102			1000							
2R2	2.2				180	18															

VRMS = 0.707 X WVDC

• SPECIAL VALUES, TOLERANCES, DIFFERENT WVDC AND MATCHING AVAILABLE. • ENCAPSULATION OPTION AVAILABLE. PLEASE CONSULT FACTORY. NOTE: EXTENDED WVDC DOES NOT APPLY TO CDR PRODUCTS.

HOW TO ORDER

Series 100

Case Size B

See mechanical dimensions below

Capacitance 910

EIA Capacitance Code in pF.
First two digits = significant figures or "R" for decimal place.
Third digit = number of zeros or after "R" significant figures

Capacitance Tolerance Code J

Code	B	C	D	F	G	J	K	M
Tol.	±1 pF	±25 pF	±5 pF	±1%	±2%	±5%	±10%	±20%

W

500

X

T

Packaging
T = Tape and Reel, 500 pc qty
TV = Vertical Tape and Reel, 500 pc qty
Please see last column of mechanical configuration table for other options.

Laser Marking (Optional)

Voltage Rating

Termination Style Code
Please see 2nd Column Mechanical Configuration Table

The above part number refers to a 100 B Series (case size B) 91 pF capacitor, J tolerance (±5%), 500 WVDC, with W termination (Tin /Lead, Solder Plated over Nickel Barrier), laser marking and Tape and Reel packaging.

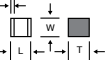
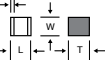
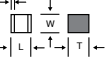
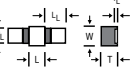
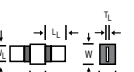
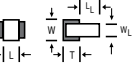
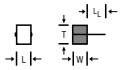
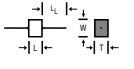
RF/Microwave Capacitors

RF/Microwave Multilayer Capacitors (MLC)

100B Series Porcelain Superchip® Multilayer Capacitors



MECHANICAL CONFIGURATION

Series & Case Size	Term. Code	MIL-PRF-55681	Case Size & Type	Outline W/T is a Termination Surface	Body Dimensions inches (mm)			Lead and Termination Dimensions and Material			Pkg Type	Pkg Code	
					Length (L)	Width (W)	Thickness (T)	Overlap (Y)	Materials				
100B	W	CDR14BG	 Solder Plate		.110+ .020 - .01 (2.79 + 0.51-0.25)	.110 ±.015 (2.79 ±0.38)	.102 (2.59) max.	.015 (0.38) ±.010 (0.25)	Tin / Lead, Solder Plated over Nickel Barrier Termination			T&R, 1000 or 500 pcs Vertical T&R, 1000 or 500 pcs Cap Pac, 100 pcs	T1K or T TV1K or TV C100
100B	P	CDR14BG	 Pellet		.110+ .035 - .01 (2.79 + 0.89-0.25)	.110 ±.015 (2.79 ±0.38)			Heavy Tin/Lead Coated, over Nickel Barrier Termination			T&R, 1000 or 500 pcs Vertical T&R, 1000 or 500 pcs Cap Pac, 100 pcs	T1K or T TV1K or TV C100
100B	T	N/A	 Solderable Nickel		.110+ .020 - .01 (2.79 + 0.51-0.25)	.110 ±.015 (2.79 ±0.38)			RoHS Compliant Tin Plated over Nickel Barrier Termination			T&R, 1000 or 500 pcs Vertical T&R, 1000 or 500 pcs Cap Pac, 100 pcs	T1K or T TV1K or TV C100
100B	CA	CDR13BG	 Gold Chip		.110+.020 - .010 (2.79 + 0.51-0.25)	.110 ±.015 (2.79 ±0.38)			RoHS Compliant Gold Plated over Nickel Barrier Termination			T&R, 1000 or 500 pcs Vertical T&R, 1000 or 500 pcs Cap Pac, 100 pcs	T1K or T TV1K or TV C100
100B	MS	CDR21BG	 Microstrip		.135 ±.015 (3.43 ±0.38)	.110 ±.015 (2.79 ±0.38)	.120 (3.05) max.	N/A	Length (L _L)	Width (W _L)	Thickness (T _L)	Cap Pac, 20 pcs	C20
100B	AR	CDR22BG	 Axial Ribbon				.102 (2.59) max.		.250 (6.35) min.	.093±.005 (2.36 ±0.13)	.004 ± .001 (.102±.025)	Box, 20 or 100 pcs	B20 or B100
100B	RR	CDR24BG	 Radial Ribbon									Box, 20 or 100 pcs	B20 or B100
100B	RW	CDR23BG	 Radial Wire		.145 ±.020 (3.68 ±0.51)				.500 (12.7)	#26 AWG., .016 (.406) dia. nominal	Box, 20 or 100 pcs	B20 or B100	
100B	AW	CDR25BG	 Axial Wire								Box, 20 or 100 pcs	B20 or B100	

Additional lead styles available: Narrow Microstrip (NM), Narrow Axial Ribbon (NA) and Vertical Narrow Microstrip (H). Other lead lengths are available; consult factory. All leads are high purity silver attached with high temperature solder and are **RoHS** compliant.

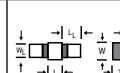
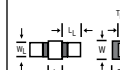
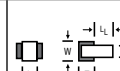
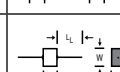
RF/Microwave Capacitors

RF/Microwave Multilayer Capacitors (MLC)

100B Series Porcelain Superchip® Multilayer Capacitors



NON-MAGNETIC MECHANICAL CONFIGURATION

Series & Case Size	Term. Code	MIL-PRF-55681	Case Size & Type	Outline W/T is a Termination Surface	Body Dimensions inches (mm)			Lead and Termination Dimensions and Material			Pkg Type	Pkg Code	
					Length (L)	Width (W)	Thickness (T)	Overlap (Y)	Materials				
100B	WN	Meets Requirements	 Non-Mag		.110+ .020 - .01 (2.79 + 0.51-0.25)	.110 ±.015 (2.79 ±0.38)	.102 (2.59) max.	.015 (0.38) ±.010 (0.25)	Tin / Lead, Solder Plated over Copper Barrier Termination			T&R, 1000 or 500 pcs Vertical T&R, 1000 or 500 pcs Cap Pac, 100 pcs	T1K or T TV1K or TV C100
100B	PN	Meets Requirements	 Solderable Nickel		.110+ .035 - .01 (2.79 + 0.51-0.25)	.110 ±.015 (2.79 ±0.38)			Heavy Tin / Lead, Coated over Non-Magnetic Barrier Termination			T&R, 1000 or 500 pcs Vertical T&R, 1000 or 500 pcs Cap Pac, 100 pcs	T1K or T TV1K or TV C100
100B	TN	Meets Requirements	 Non-Mag Solderable Barrier		.110+.020 - .010 (2.79 + 0.51-0.25)	.110 ±.015 (2.79 ±0.38)			RoHS Compliant Tin Plated over Non-Magnetic Barrier Termination			T&R, 1000 or 500 pcs Vertical T&R, 1000 or 500 pcs Cap Pac, 100 pcs	T1K or T TV1K or TV C100
100B	MN	Meets Requirements	 Microstrip		.135 ±.015 (3.43 ±0.38)	.110 ±.015 (2.79 ±0.38)	.120 (3.05) max.	N/A	Length (L _L)	Width (W _L)	Thickness (T _L)	Cap Pac, 20 pcs	C20
100B	AN	Meets Requirements	 Axial Ribbon				.102 (2.59) max.		.250 (6.35) (6.35) min.	.093±.005 (2.36 ±0.13)	.004 ± .001 (.102±.025)	Box, 20 or 100 pcs	B20 or B100
100B	FN	Meets Requirements	 Radial Ribbon									Box, 20 or 100 pcs	B20 or B100
100B	RN	Meets Requirements	 Radial Wire		.145 ±.020 (3.68 ±0.51)				.500 (12.7)	#26 AWG., .016 (.406) dia. nominal	Box, 20 or 100 pcs	B20 or B100	
100B	BN	Meets Requirements	 Axial Wire								Box, 20 or 100 pcs	B20 or B100	

Additional lead styles available: Narrow Microstrip (NM), Narrow Axial Ribbon (NA) and Vertical Narrow Microstrip (H). Other lead lengths are available; consult factory. All leads are high purity silver attached with high temperature solder and are **RoHS** compliant.

RF/Microwave Capacitors

RF/Microwave Multilayer Capacitors (MLC)

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SUGGESTED MOUNTING PAD DIMENSIONS

Horizontal
Electrode Orientation

Vertical
Electrode Orientation

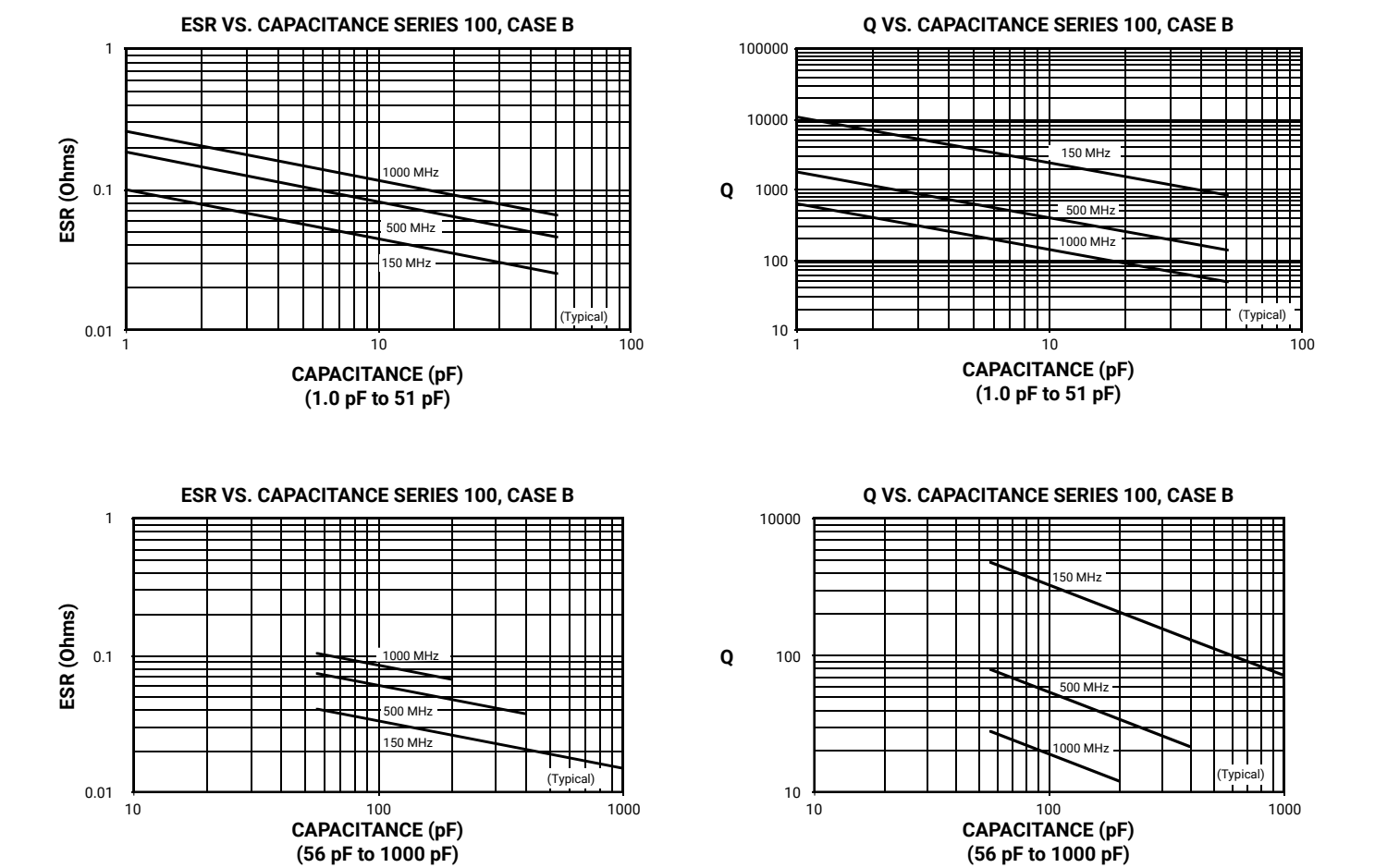
Case B Vertical Mount

Cap Value	Pad Size	A Min.	B Min.	C Min.	D Min.
0.1 pF	Normal	.065	.050	.075	.175
	High Density	.045	.030	.075	.135
0.2 pF	Normal	.090	.050	.075	.175
	High Density	.070	.030	.075	.135
0.3 to 510 pF	Normal	.110	.050	.075	.175
	High Density	.090	.030	.075	.135
> 510 pF	Normal	.120	.050	.075	.175
	High Density	.100	.030	.075	.135

Horizontal Mount

All Values	Pad Size	A Min.	B Min.	C Min.	D Min.
All Values	Normal	.130	.050	.075	.175
	High Density	.110	.030	.075	.135

PERFORMANCE DATA

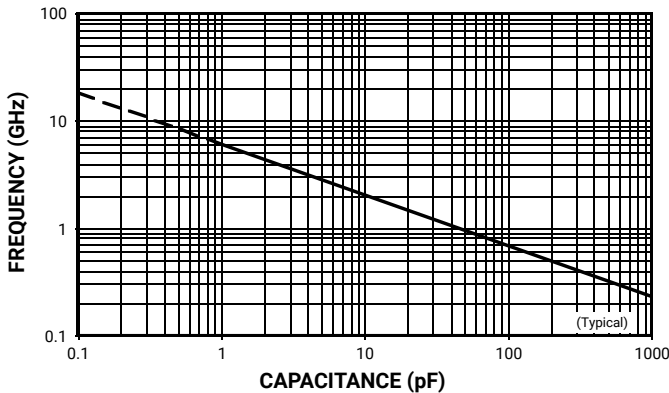


RF/Microwave Capacitors
RF/Microwave Multilayer Capacitors (MLC)
100B Series Porcelain Superchip® Multilayer Capacitors

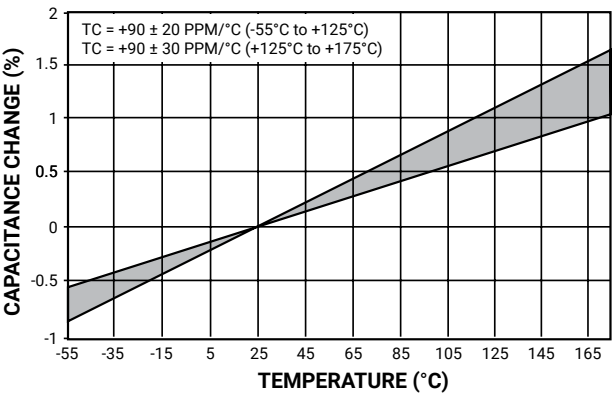


PERFORMANCE DATA

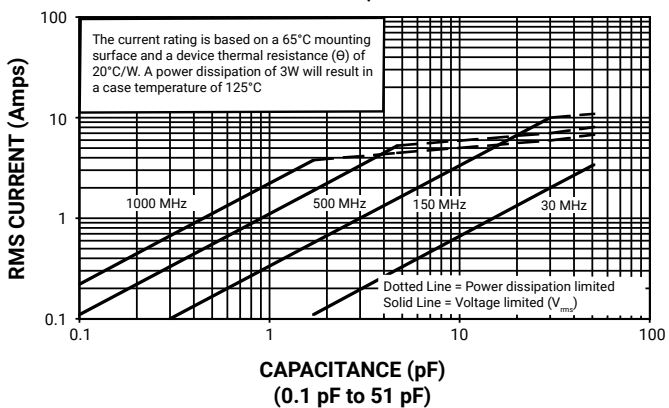
SERIES RESONANCE VS. CAPACITANCE
SERIES 100, CASE B



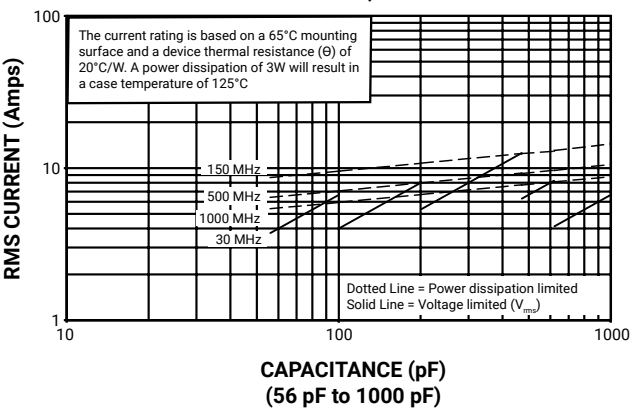
CAPACITANCE CHANGE VS. TEMPERATURE
SERIES 100, CASE B



CURRENT RATING VS. CAPACITANCE
SERIES 100, CASE B

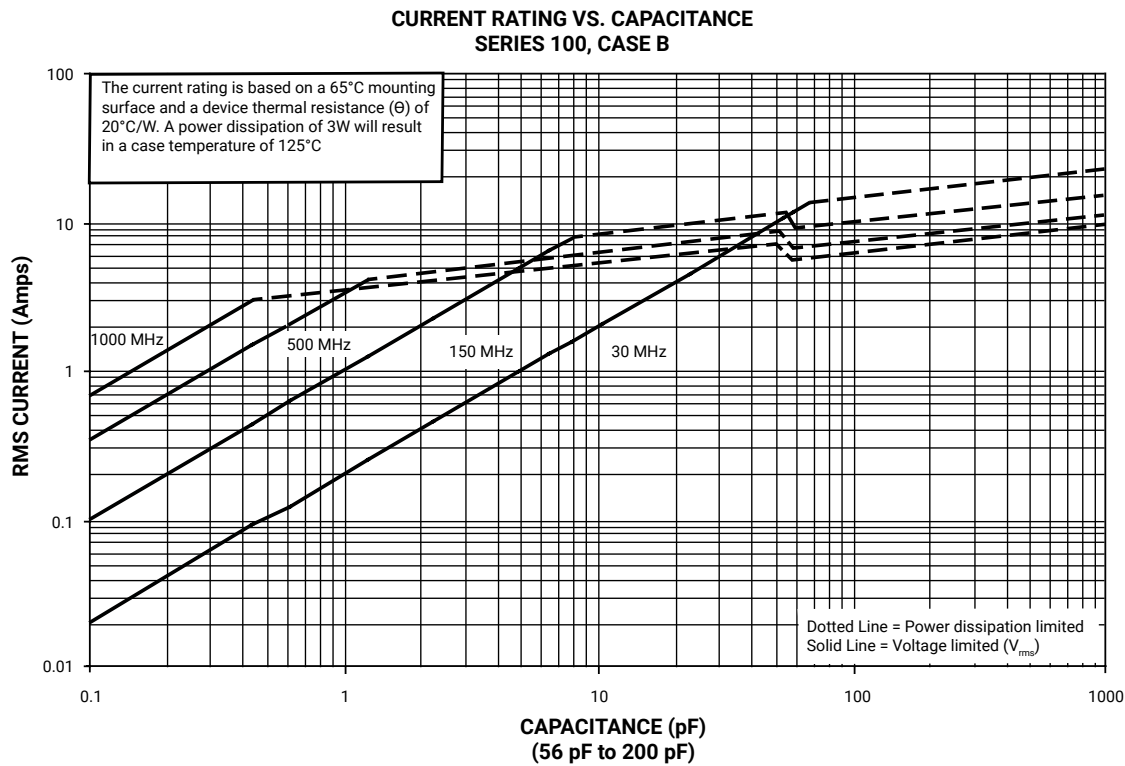


CURRENT RATING VS. CAPACITANCE
SERIES 100, CASE B



RF/Microwave Capacitors
RF/Microwave Multilayer Capacitors (MLC)
100B Series Porcelain Superchip® Multilayer Capacitors

PERFORMANCE DATA



DESIGN KITS

Kit #	RoHS Compliant	Item #	Description	Cap. Value Range (pF)	Cap. Value (pF)	Tol. (pF)	Price
Kit 9		DK0009	100B Porcelain Superchip®, 16 different values, 15 pcs. min. per value	0.1 to 2.0	10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100	±5%	\$180.00
Kit 9T		DK0009T					
Kit 10		DK0010	100B Porcelain Superchip®, 16 different values, 15 pcs. min. per value	10 to 27	100, 120, 150, 180, 200, 220, 240, 270, 300, 330, 390, 470..... 560, 680, 820, 1000.....	±5%	\$180.00
Kit 10T		DK0010T					

For Online Kit Orders, Catalog & Application Notes, Visit: www.kyocera-avx.com